

Amendments to the Abstract are as follows:

~~An electronic circuit unit, in which a wire of a semiconductor bare chip does not break, which electronic circuit can be mounted by a mounting machine, can be simply manufactured, and can be obtained at a low price, and a method of manufacturing the electronic circuit unit are provided. An~~The electronic circuit unit ~~includes~~comprises a substrate 4 on which a wiring pattern is provided; electronic parts, including a semiconductor bare chip 2 disposed on a surface 4a of the substrate-1; and a soft sealing resin-4 provided on the substrate 4 so as to cover the electronic parts,~~wherein A~~a wire 3 of the semiconductor bare chip 2 is connected to the wiring pattern and is covered with the soft sealing resin 4, and a protection member 5-made of a resin harder than the sealing resin-4-having an upper wall 5b having a flat external surface 5a and leg parts 5e extending from the upper wall 5b to the substrate 4. Since the leg parts 5e are secured to the substrate 4 while the protection member 5 covers the sealing resin-4, the protection member 5 can protect the sealing resin 4-without being cracked even when external force is applied to the protection member 5, thereby preventing the wire 3 from breaking.